



TTM Technologies, Inc. Announces Upcoming Conference Participation

November 19, 2018

COSTA MESA, Calif., Nov. 19, 2018 (GLOBE NEWSWIRE) -- TTM Technologies, Inc. (NASDAQ:TTMI), a leading global printed circuit board (PCB) manufacturer and radio frequency ("RF") components manufacturer, today announced that members of its management team will present at the following investor conference:

- Barclays Global Technology, Media and Telecommunications Conference in San Francisco at the Palace Hotel on December 5, 2018 at 3:30pm Pacific Time.

All presentations will be webcast live on the company's website, www.ttm.com, and a replay will be accessible for a limited time following the events.

About TTM

TTM Technologies, Inc. is a leading global printed circuit board manufacturer, focusing on quick-turn and volume production of technologically advanced PCBs, backplane assemblies and electro-mechanical solutions as well as a global designer and manufacturer of RF and microwave components and assemblies. TTM stands for time-to-market, representing how TTM's time-critical, one-stop manufacturing services enable customers to shorten the time required to develop new products and bring them to market. Additional information can be found at www.ttm.com.

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